DATA SHEET

For a complete data sheet, please also download:

- The IC06 74HC/HCT/HCU/HCMOS Logic Family Specifications
- The IC06 74HC/HCT/HCU/HCMOS Logic Package Information
- The IC06 74HC/HCT/HCU/HCMOS Logic Package Outlines

74HC/HCT273

Octal D-type flip-flop with reset; positive-edge trigger

Product specification
File under Integrated Circuits, IC06

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Philips Semiconductors

PHILIPS

Octal D-type flip-flop with reset; positive-edge trigger

74HC/HCT273

FEATURES

- Ideal buffer for MOS microprocessor or memory
- Common clock and master reset
- Eight positive edge-triggered D-type flip-flops
- See “377” for clock enable version
- See “373” for transparent latch version
- See “374” for 3-state version
- Output capability; standard
- I_{CC} category: MSI

GENERAL DESCRIPTION

The 74HC/HCT273 are high-speed Si-gate CMOS devices and are pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT273 have eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common clock (CP) and master reset ($\overline{MR}$) inputs load and reset (clear) all flip-flops simultaneously.
The state of each D input, one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding output (Q_n) of the flip-flop.

All outputs will be forced LOW independently of clock or data inputs by a LOW voltage level on the $\overline{MR}$ input.

The device is useful for applications where the true output only is required and the clock and master reset are common to all storage elements.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; $t_r = t_f$ = 6 ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC	HCT	
t_{PHL}/ t_{PLH}	propagation delay	C_L = 15 pF; V_{CC} = 5 V			
	CP to Q_n		15	15	ns
	$\overline{MR}$ to Q_n		15	20	ns
f_{max}	maximum clock frequency		66	36	MHz
C_I	input capacitance		3.5	3.5	pF
C_{PD}	power dissipation capacitance per flip-flop	notes 1 and 2	20	23	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in µW):

   $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

   f_i = input frequency in MHz

   f_o = output frequency in MHz

   $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs

   C_L = output load capacitance in pF

   V_{CC} = supply voltage in V

2. For HC the condition is V_I = GND to V_{CC}
   For HCT the condition is V_I = GND to V_{CC} – 1.5 V

ORDERING INFORMATION

See *“74HC/HCT/HCU/HCMOS Logic Package Information”*.

PIN DESCRIPTION

PIN NO.	SYMBOL	NAME AND FUNCTION
1	$\overline{MR}$	master reset input (active LOW)
2, 5, 6, 9, 12, 15, 16, 19	Q_0 to Q_7	flip-flop outputs
3, 4, 7, 8, 13, 14, 17, 18	D_0 to D_7	data inputs
10	GND	ground (0 V)
11	CP	clock input (LOW-to-HIGH, edge-triggered)
20	V_{CC}	positive supply voltage

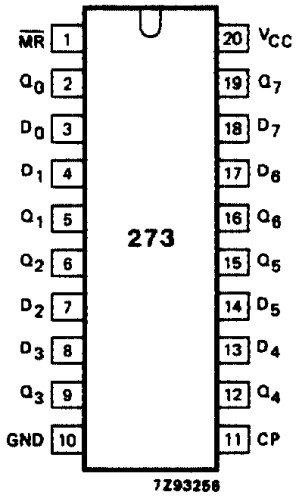


Fig.1 Pin configuration.

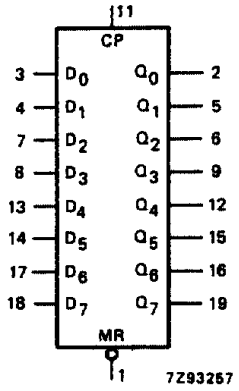


Fig.2 Logic symbol.

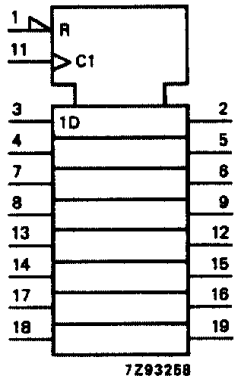


Fig.3 IEC logic symbol.

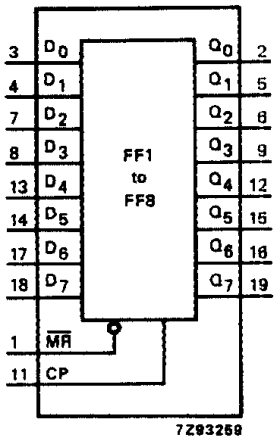


Fig.4 Functional diagram.

FUNCTION TABLE

OPERATING MODES	INPUTS			OUTPUTS
	$\overline{MR}$	CP	D_n	Q_n
reset (clear)	L	X	X	L
load “1”	H	↑	h	H
load “0”	H	↑	l	L

Note

1. H = HIGH voltage level
   h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition
   L = LOW voltage level
   l = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition
   ↑ = LOW-to-HIGH transition
   X = don’t care

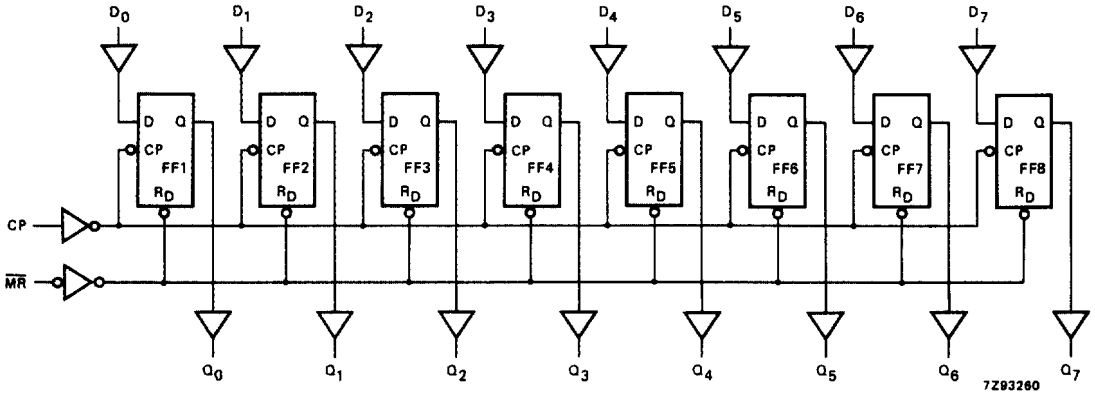


Fig.5 Logic diagram.

DC CHARACTERISTICS FOR 74HC

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: standard
I_{CC} category: MSI

AC CHARACTERISTICS FOR 74HC

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T_{amb} (°C)							UNIT	TEST CONDITIONS	
		74HC								V_{CC} (V)	WAVEFORMS
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PHL}/ t_{PLH}	propagation delay CP to Q_n		41 15 13	150 30 26		185 37 31		225 45 38	ns	2.0 4.5 6.0	Fig.6
t_{PHL}	propagation delay $\overline{MR}$ to Q_n		44 16 14	150 30 26		185 37 31		225 45 38	ns	2.0 4.5 6.0	Fig.7
t_{THL}/ t_{TLH}	output transition time		19 7 6	75 15 13		95 19 15		110 22 19	ns	2.0 4.5 6.0	Fig.6
t_W	clock pulse width HIGH or LOW	80 16 14	14 5 4		100 20 17		120 24 20		ns	2.0 4.5 6.0	Fig.6
t_W	master reset pulse width LOW	60 12 10	17 6 5		75 15 13		90 18 15		ns	2.0 4.5 6.0	Fig.7
t_{rem}	removal time $\overline{MR}$ to CP	50 10 9	−6 −2 −2		65 13 11		75 15 13		ns	2.0 4.5 6.0	Fig.7
t_{su}	set-up time D_n to CP	60 12 10	11 4 3		75 15 13		90 18 15		ns	2.0 4.5 6.0	Fig.8
t_h	hold time D_n to CP	3 3 3	−6 −2 −2		3 3 3		3 3 3		ns	2.0 4.5 6.0	Fig.8
f_{max}	maximum clock pulse frequency	6.0 30 35	20.6 103 122		4.8 24 28		4.0 20 24		MHz	2.0 4.5 6.0	Fig.6

DC CHARACTERISTICS FOR 74HCT

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: standard
I_{CC} category: MSI

Note to HCT types

The value of additional quiescent supply current (ΔI_{CC}) for a unit load of 1 is given in the family specifications. To determine ΔI_{CC} per input, multiply this value by the unit load coefficient shown in the table below.

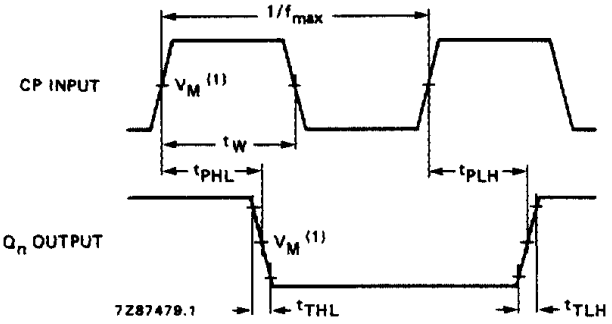
INPUT	UNIT LOAD COEFFICIENT
$\overline{MR}$	1.00
CP	1.75
D_n	0.15

AC CHARACTERISTICS FOR 74HCT

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF

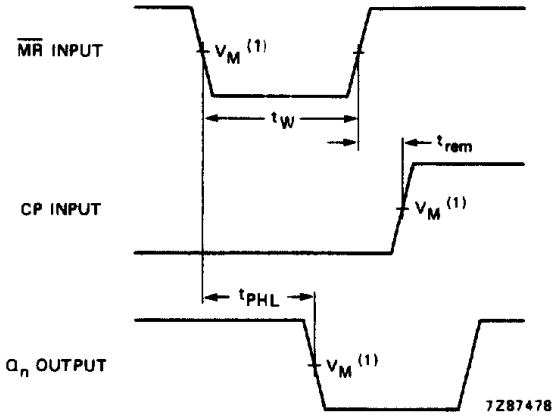
SYMBOL	PARAMETER	T_{amb} (°C)							UNIT	TEST CONDITIONS	
		74HCT								V_{CC} (V)	WAVEFORMS
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PHL}/ t_{PLH}	propagation delay CP to Q_n		16	30		38		45	ns	4.5	Fig.6
t_{PHL}	propagation delay $\overline{MR}$ to Q_n		23	34		43		51	ns	4.5	Fig.7
t_{THL}/ t_{TLH}	output transition time		7	15		19		22	ns	4.5	Fig.6
t_W	clock pulse width HIGH or LOW	16	9		20		24		ns	4.5	Fig.6
t_W	master reset pulse width LOW	16	8		20		24		ns	4.5	Fig.7
t_{rem}	removal time $\overline{MR}$ to CP	10	−2		13		15		ns	4.5	Fig.7
t_{su}	set-up time D_n to CP	12	5		15		18		ns	4.5	Fig.8
t_h	hold time D_n to CP	3	−4		3		3		ns	4.5	Fig.8
f_{max}	maximum clock pulse frequency	30	56		24		20		MHz	4.5	Fig.6

AC WAVEFORMS



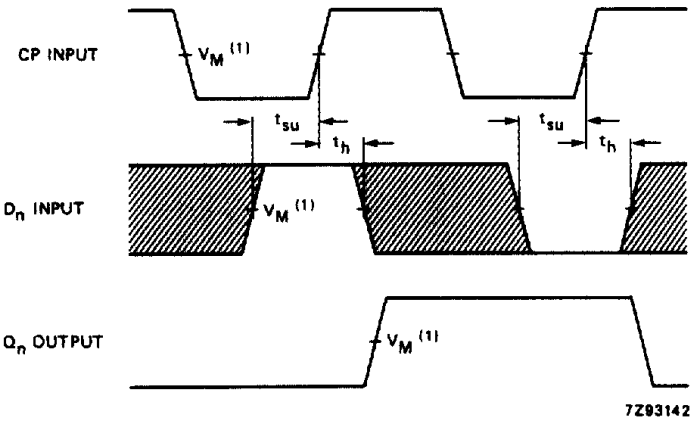
(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.6 Waveforms showing the clock (CP) to output (Q_n) propagation delays, the clock pulse width output transition times and the maximum clock pulse frequency.



(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.7 Waveforms showing the master reset ($\overline{MR}$) pulse width, the master reset to output (Q_n) propagation delays and the master reset to clock (CP) removal time.



The shaded areas indicate when the input is permitted to change for predictable output performance.

(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.8 Waveforms showing the data set-up and hold times for the data input (D_n).

PACKAGE OUTLINES

See *"74HC/HCT/HCU/HCMOS Logic Package Outlines"*.

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